

[illegible]

描述 / Descriptions

T U V F W A X Y Z O [\] ^ _ 2000V O ` \] A _ 1.0A OSMA a F b

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特征 / Features

c d e f g h O i j k l m n RoHS o p 2011/65/EU O q r T U V F b i s t u b

用途 / Applications

v w r x .

内部等效电路 / Equivalent Circuit



引脚排列 / Pinning



2

PIN	DESCRIPTION
1	Cathode
2	Anode

The recommended mounting pad size is 6.4mm x 3.2mm.



印章代码 / Marking

y z { | } b



参数	符号	数值	单位
	()		
			℃
			℃

)
)

参数 符号 测试条件



电参数曲线图 / Electrical Characteristic Curve

Fig.1 Forward Current Derating Curve



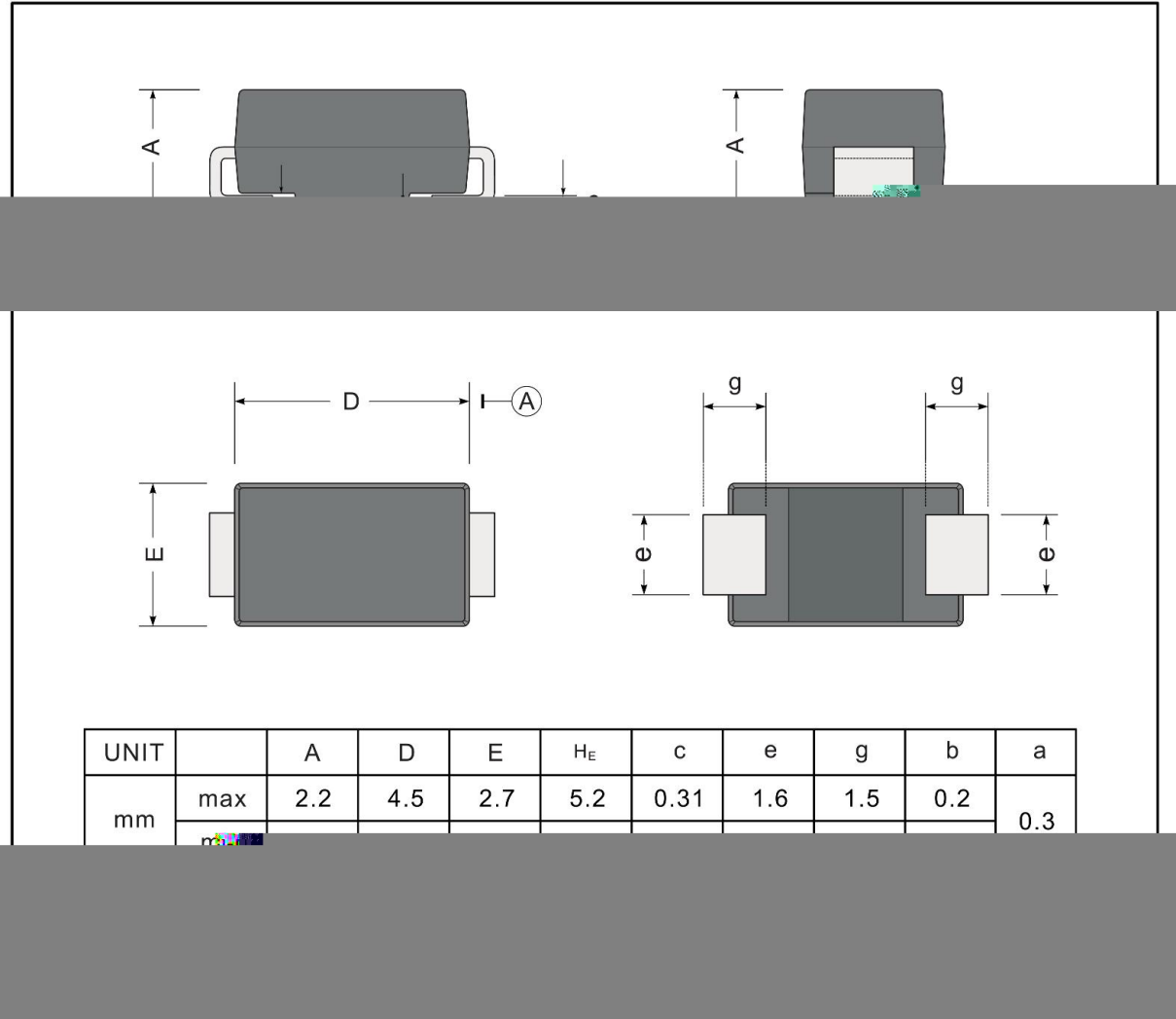
Fig.2 Typical Reverse Characteristics





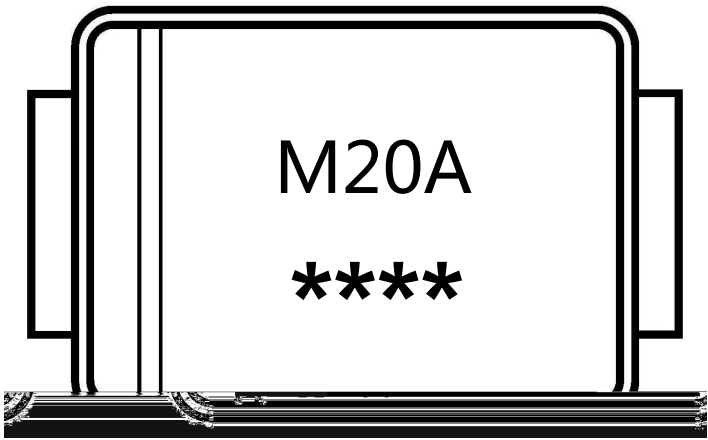
外形尺寸图 / Package Dimensions

SMA





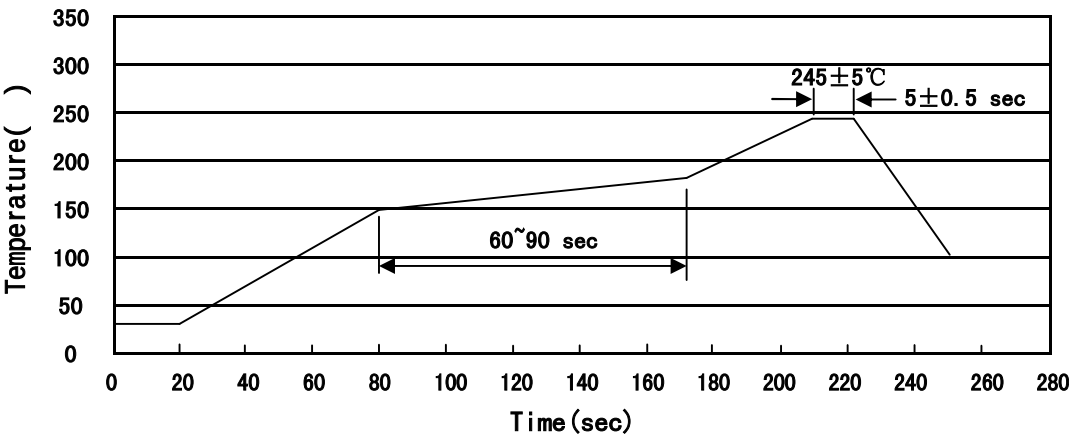
印章说明 / Marking Instructions



M20A			
****	1 *	3 *	
M20A			
****	*		*



回流焊温度曲线图(无铅) / Temperature Profile for IR Reflow Soldering(Pb-Free)



± °C ± °C ± °C ± °C

耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions

± °C ± °C ± °C ± °C

包装规格 / Packaging SPEC.

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
						"		

使用说明 / Notices